16-bit D-type transparent latch with 5 V tolerant inputs/outputs; 3-state

Rev. 7 — 18 January 2013

Product data sheet

1. General description

The 74LVCH16373A and 74LVCH16373A are 16-bit D-type transparent latches featuring separate D-type inputs with bus hold (74LVCH16373A only) for each latch and 3-state outputs for bus-oriented applications. One Latch Enable (LE) input and one Output Enable (\overline{OE}) are provided for each octal. Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

The device consists of two sections of eight D-type transparent latches with 3-state true outputs. When LE is HIGH, data at the Dn inputs enter the latches. In this condition, the latches are transparent, that is, the latch outputs change each time its corresponding D-input changes. The latches store the information that was present at the D-inputs one set-up time (t_{su}) preceding the HIGH-to-LOW transition of LE. When \overline{OE} is LOW, the contents of the eight latches are available at the outputs. When \overline{OE} is HIGH, the outputs go to the high impedance OFF-state. Operation of the \overline{OE} input does not affect the state of the latches. Bus hold on the data inputs eliminates the need for external pull-up resistors to hold unused inputs.

2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Multibyte flow-through standard pinout architecture
- Multiple low inductance supply pins for minimum noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bus hold (74LVCH16373A only)
- High-impedance when V_{CC} = 0 V
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from –40 °C to +85 °C and –40 °C to +125 °C

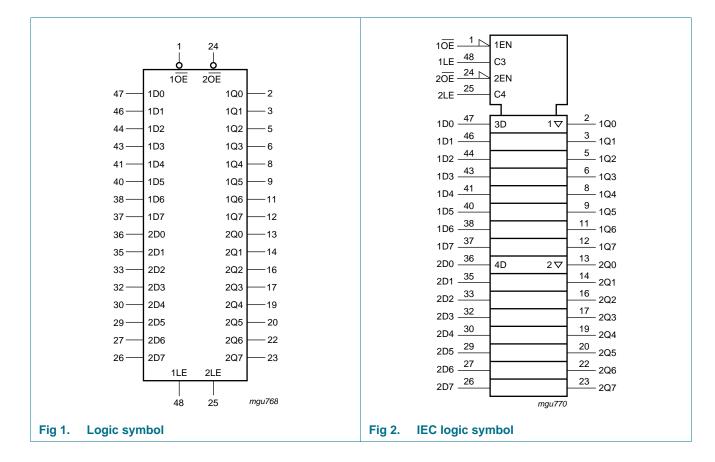


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3. Ordering information

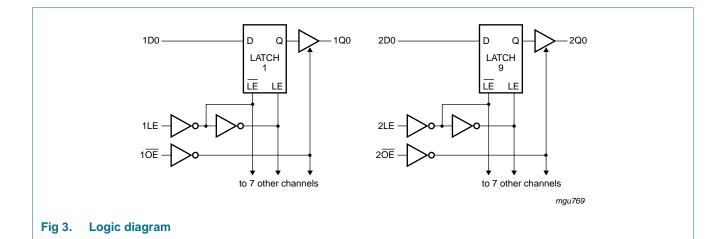
Type number	Package							
	Temperature range	Name	Description	Version				
74LVC16373ADGG	–40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package;	SOT362-1				
74LVCH16373ADGG			48 leads; body width 6.1 mm					
74LVC16373ADL	–40 °C to +125 °C	SSOP48	plastic shrink small outline package; 48 leads;	SOT370-1				
74LVCH16373ADL			body width 7.5 mm					

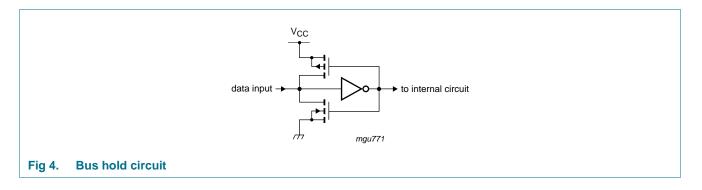
4. Functional diagram



74LVC16373A; 74LVCH16373A

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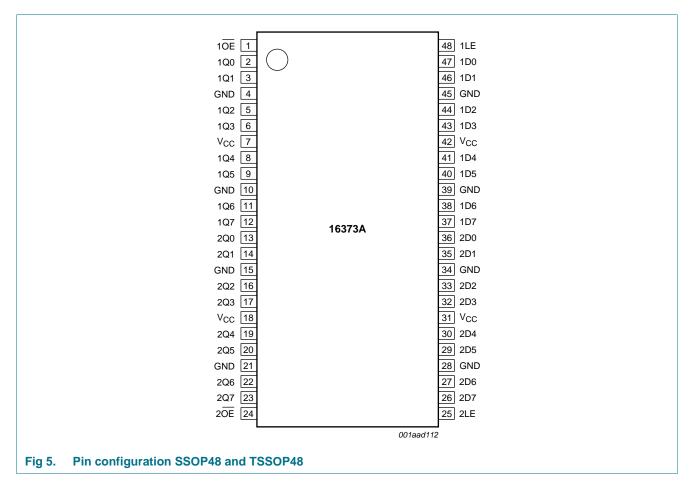




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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
1 <mark>OE</mark>	1	output enable input (active LOW)
2 <mark>0E</mark>	24	output enable input (active LOW)
1LE	48	latch enable input (active HIGH)
2LE	25	latch enable input (active HIGH)
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V _{CC}	7, 18, 31, 42	supply voltage
1Q[0:7]	2, 3, 5, 6, 8, 9, 11, 12	data output
2Q[0:7]	13, 14, 16, 17, 19, 20, 22, 2	3 data output
1D[0:7]	47, 46, 44, 43, 41, 40, 38, 3	7 data input
2D[0:7]	36, 35, 33, 32, 30, 29, 27, 2	6 data input

74LVC_LVCH16373A

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16-bit D-type transparent latch with 5 V tolerant inputs/outputs; 3-state

6. Functional description

Table 3. Function table

Per section of eight bits [1].

Operating modes	Input		Internal latch	Output	
	nOE	nLE	nDn		nQ0 to nQ7
Enable and read register (transparent mode)	L	Н	L	L	L
	L	Н	Н	Н	Н
Latch and read register	L	L	Ι	L	L
	L	L	h	Н	Н
Latch register and disable outputs	Н	L	I	L	Z
	Н	L	h	Н	Z

[1] H = HIGH voltage level

h = HIGH voltage level one set-up time prior to the HIGH to LOW LE transition

L = LOW voltage level

I = LOW voltage level one set-up time prior to the HIGH to LOW LE transition

Z = high-impedance OFF-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Parameter	Conditions	Min	Max	11
			Max	Unit
supply voltage		-0.5	+6.5	V
input clamping current	V ₁ < 0	-50	-	mA
input voltage		<u>[1]</u> –0.5	+6.5	V
output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0	-	±50	mA
output voltage	output HIGH or LOW state	<u>[2]</u> –0.5	V _{CC} + 0.5	V
	output 3-state	<u>[2]</u> –0.5	+6.5	V
output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
supply current		-	100	mA
ground current		-100	-	mA
storage temperature		-65	+150	°C
total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$	<u>[3]</u>	500	mW
	input clamping current input voltage output clamping current output voltage output current supply current ground current storage temperature	$\begin{array}{ll} \text{input clamping current} & V_{I} < 0 \\ \text{input voltage} & & \\ \text{output clamping current} & V_{O} > V_{CC} \text{ or } V_{O} < 0 \\ \text{output voltage} & & \\ \hline \text{output Voltage} & & \\ \hline \text{output 3-state} & \\ \text{output current} & & \\ \text{supply current} & & \\ \text{ground current} & \\ \text{storage temperature} & & \\ \end{array}$	$\begin{array}{ccc} \text{input clamping current} & V_{I} < 0 & -50 \\ \text{input voltage} & & 11 & -0.5 \\ \text{output clamping current} & V_{O} > V_{CC} \text{ or } V_{O} < 0 & - \\ \text{output voltage} & & \text{output HIGH or LOW state} & & 2 & -0.5 \\ \hline & & \text{output 3-state} & & 2 & -0.5 \\ \hline & & \text{output current} & V_{O} = 0 \text{ V to } V_{CC} & - \\ \text{supply current} & & & - \\ \text{ground current} & & & -100 \\ \text{storage temperature} & & & -65 \\ \end{array}$	input clamping current $V_1 < 0$ -50 -50 input voltage[1] -0.5 $+6.5$ output clamping current $V_0 > V_{CC}$ or $V_0 < 0$ $ \pm 50$ output voltageoutput HIGH or LOW state[2] -0.5 $V_{CC} + 0.5$ output current $V_0 = 0$ V to V_{CC} $ \pm 50$ output current $V_0 = 0$ V to V_{CC} $ \pm 50$ supply current $ -100$ $-$ ground current -100 $ -65$ $+150$

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] Above 60 °C, the value of P_{tot} derates linearly with 5.5 mW/K.

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8. Recommended operating conditions

Table 5.	Recommended operating conditions										
Symbol	Parameter	Conditions	Min	Тур	Max	Unit					
V _{CC}	supply voltage		1.65	-	3.6	V					
		functional	1.2	-	3.6	V					
VI	input voltage		0	-	5.5	V					
Vo	output voltage	output HIGH or LOW state	0	-	V _{CC}	V					
		output 3-state	0	-	5.5	V					
T _{amb}	ambient temperature	in free air	-40	-	+125	°C					
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V					
		V _{CC} = 2.7 V to 3.6 V	0	-	10	ns/V					

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	–40 °C to	o +125 ℃	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
VIH	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{\text{CC}}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V_{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V
V _{OH} HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V	
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		I_{O} = -8 mA; V_{CC} = 2.3 V	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
lı	input leakage current	V _{CC} = 3.6 V; V _I = 5.5 V or GND ^[2]	-	±0.1	±5	-	±20	μΑ

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Symbol	Parameter	Conditions	-40	0 °C to +85	°C	–40 °C to	o +125 ℃	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V};$ $V_{O} = 5.5 \text{ V or GND}^{[2]}$	-	±0.1	±5	-	±20	μA
I _{OFF}	power-off leakage current	V_{CC} = 0 V; V _I or V _O = 5.5 V	-	±0.1	±10	-	±20	μA
I _{CC}	supply current	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 3.6 \ V; \ V_{I} = V_{CC} \ \text{or GND}; \\ I_{O} = 0 \ A \end{array}$	-	0.1	20	-	80	μΑ
∆l _{CC}	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_{I} = V_{CC} - 0.6 V; I_{O} = 0 A$	-	5	500	-	5000	μA
Cı	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_I = GND \text{ to } V_{CC}$	-	5.0	-	-	-	pF
I _{BHL}	bus hold	V _{CC} = 1.65; V _I = 0.58 V _{[3][4]}	10	-	-	10	-	μA
	LOW current	$V_{CC} = 2.3; V_I = 0.7 V$	30	-	-	25	-	μΑ
		$V_{CC} = 3.0; V_I = 0.8 V$	75	-	-	60	-	μA
I _{BHH}	bus hold	$V_{CC} = 1.65; V_I = 1.07 V_{[3][4]}$	-10	-	-	-10	-	μA
	HIGH current	$V_{CC} = 2.3; V_I = 1.7 V$	-30	-	-	-25	-	μA
		$V_{CC} = 3.0; V_{I} = 2.0 V$	-75	-	-	-60	-	μΑ
I _{BHLO}	bus hold	V _{CC} = 1.95 V[3][5]	200	-	-	200	-	μΑ
	LOW overdrive	$V_{CC} = 2.7 V$	300	-	-	300	-	μΑ
	current	V _{CC} = 3.6 V	500	-	-	500	-	μΑ
I _{BHHO}	bus hold	V _{CC} = 1.95 V ^{[3][5]}	-200	-	-	-200	-	μA
	HIGH overdrive	$V_{CC} = 2.7 V$	-300	-	-	-300	-	μA
	current	V _{CC} = 3.6 V	-500	-	-	-500	-	μΑ

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

[2] The bus hold circuit is switched off when $V_I > V_{CC}$ allowing 5.5 V on the input pin.

[3] Valid for data inputs (74LVCH16373A) only; control inputs do not have a bus hold circuit.

[4] The specified sustaining current at the data inputs holds the input below the specified V₁ level.

[5] The specified overdrive current at the data input forces the data input to the opposite logic input state.

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10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 10</u>.

Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	+85 °C	-40 °C to	+125 ℃	Unit
				Min	Typ <mark>[1]</mark>	Мах	Min	Max	-
t _{pd}	propagation	Dn to Qn; see <u>Figure 6</u>	[2]	I			I	I	1
	delay	$V_{CC} = 1.2 V$		-	12	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	5.4	11.4	1.5	13.2	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.9	5.7	1.0	6.6	ns
		$V_{CC} = 2.7 V$		1.5	2.9	4.9	1.5	6.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	2.4	4.4	1.0	5.5	ns
		LE to Qn; see Figure 7							
		$V_{CC} = 1.2 V$		-	14	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		2.0	6.4	12.4	2.0	14.4	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.4	6.1	1.5	7.1	ns
		$V_{CC} = 2.7 V$		1.5	3.0	5.3	1.5	7.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	2.9	4.8	1.5	6.0	ns
t _{en}	enable time	OE to Qn; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	18	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	5.5	12.4	1.5	14.3	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	3.1	6.6	1.0	7.6	ns
		$V_{CC} = 2.7 V$		1.5	3.3	5.7	1.5	7.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	2.5	4.9	1.0	6.5	ns
t _{dis}	disable time	OE to Qn; see Figure 8	[2]						
		$V_{CC} = 1.2 V$		-	11	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		2.8	4.5	9.1	2.8	10.5	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.5	5.1	1.0	6.0	ns
		$V_{CC} = 2.7 V$		1.5	3.3	6.3	1.5	8.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.1	5.4	1.5	7.0	ns
t _W	pulse width	LE HIGH; see Figure 7							
		V_{CC} = 1.65 V to 1.95 V		5.0	-	-	5.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$		3.0	-	-	3.0	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		3.0	2.0	-	3.0	-	ns
t _{su}	set-up time	Dn to LE; see Figure 9							
		V_{CC} = 1.65 V to 1.95 V		3.0	-	-	3.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		$V_{CC} = 2.7 V$		2.0	-	-	2.0	-	ns
		V_{CC} = 3.0 V to 3.6 V		2.0	1.0	-	2.0	-	ns

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Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	+85 °C	–40 °C to +125 °C		Unit
					Typ <mark>[1]</mark>	Max	Min	Max	
t _h hold time		Dn to LE; see Figure 9							
		V_{CC} = 1.65 V to 1.95 V		2.5	-	-	2.5	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 V$		0.9	-	-	0.9	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		+0.9	-1.0	-	+0.9	-	ns
t _{sk(o)}	output skew time	$V_{CC} = 3.0 V \text{ to } 3.6 V$	<u>[3]</u>	-	-	1.0	-	1.5	ns
C _{PD}	power	per input; $V_I = GND$ to V_{CC}	[4]						
	dissipation capacitance	$V_{CC} = 1.65 \text{ V}$ to 1.95 V		-	10.8	-	-	-	pF
	capacitance	V_{CC} = 2.3 V to 2.7 V		-	13.0	-	-	-	pF
		V_{CC} = 3.0 V to 3.6 V		-	15.0	-	-	-	pF

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

[1] Typical values are measured at $T_{amb} = 25$ °C and $V_{CC} = 1.2$ V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

 t_{en} is the same as t_{PZL} and t_{PZH} .

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

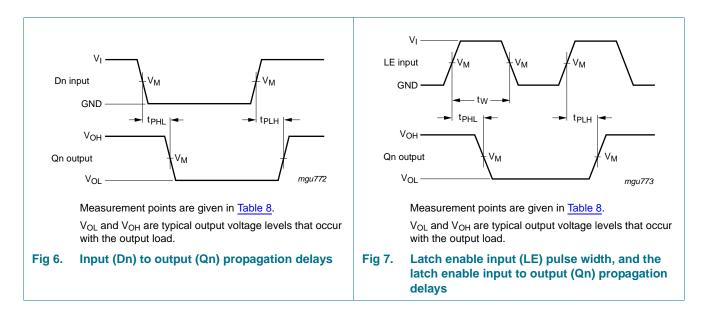
 C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

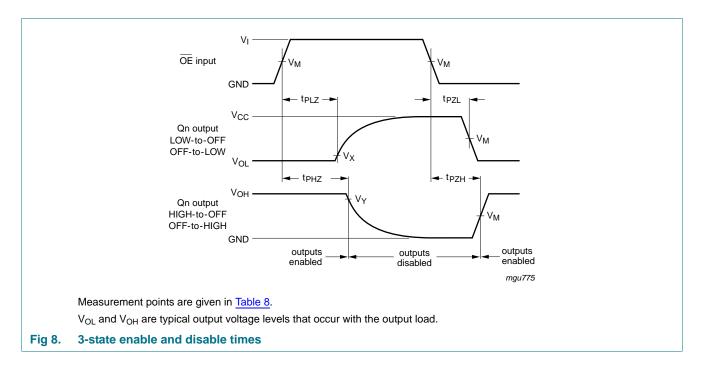
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs

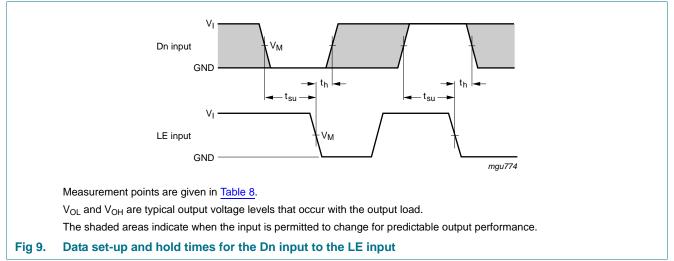
11. Waveforms



74LVC16373A; 74LVCH16373A

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Table 8. Measurement points

Supply voltage	Input		Output					Output		
V _{cc}	VI	V _M	V _M	V _X	V _Y					
1.2 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V					
1.65 V to 1.95 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V					
2.3 V to 2.7 V	V _{CC}	$0.5 \times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V					
2.7 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V					
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V					

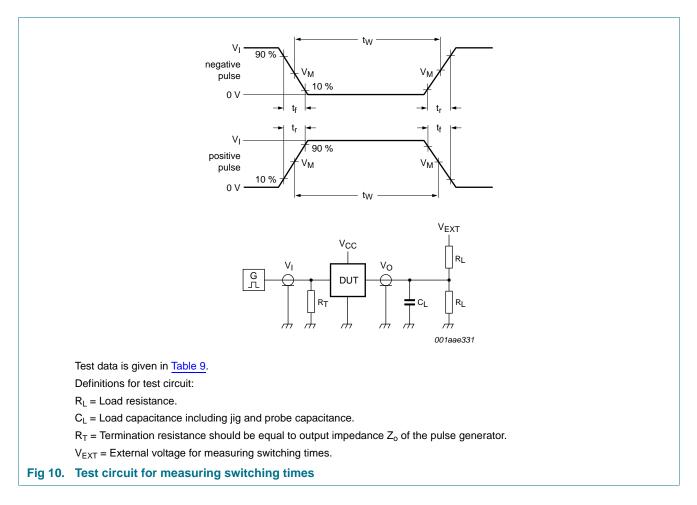


Table 9. Test data

Supply voltage	Input		Load		V _{EXT}	V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

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12. Package outline

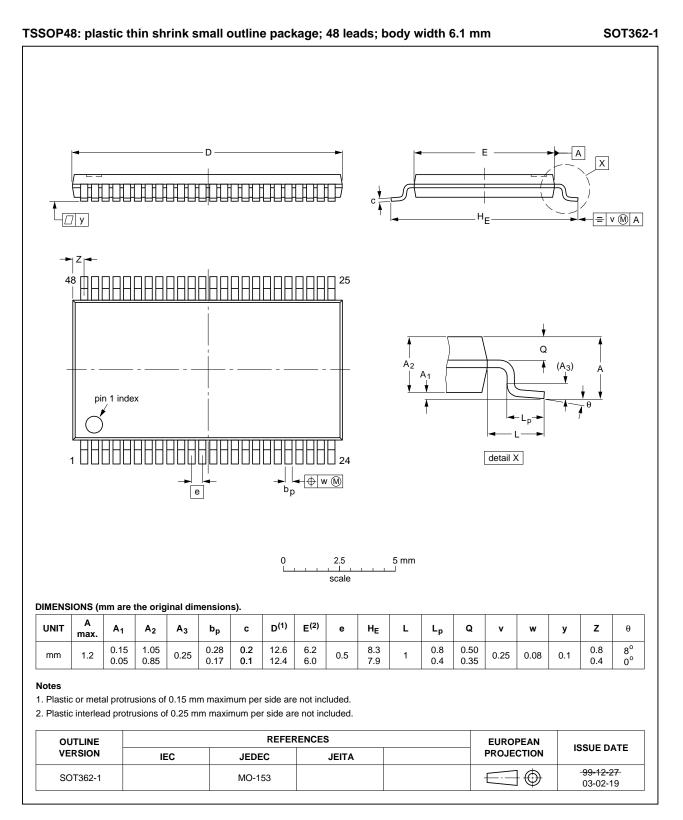


Fig 11. Package outline SOT362-1 (TSSOP-48)

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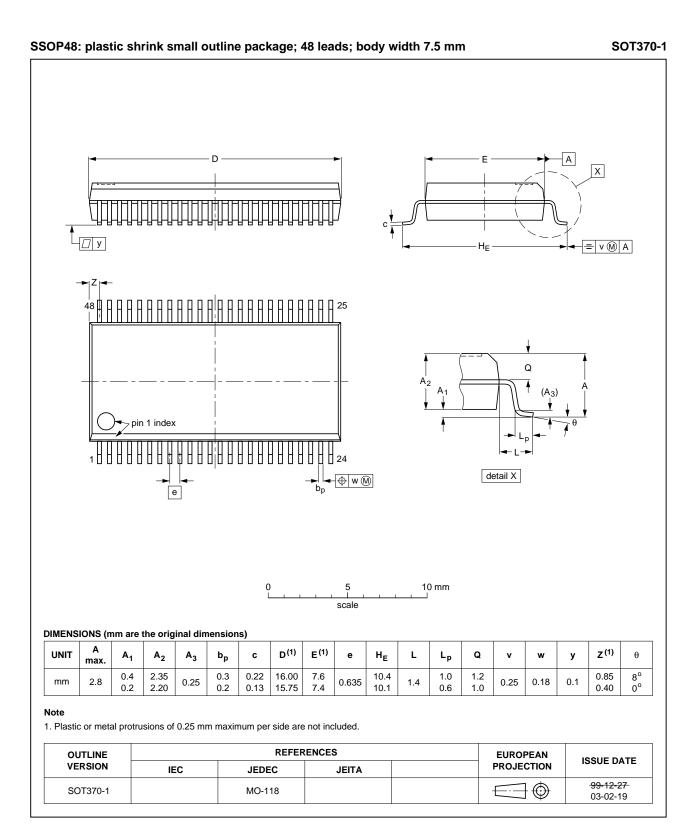


Fig 12. Package outline SOT370-1 (SSOP48)

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13. Abbreviations

Table 10. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

14. Revision history

Table 11. Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes		
74LVC_LVCH16373A v.7	20130118	Product data sheet	-	74LVC_LVCH16373A v.6		
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 					
	 Legal te 	exts have been adapted	to the new co	ompany name where appropriate.		
	 <u>Table 5</u> ranges. 	, <u>Table 6</u> , <u>Table 7</u> , <u>Table</u>	8 and <u>Table</u>	<u>9</u> : values added for lower voltage		
74LVC_LVCH16373A v.6	20031208	Product specification	-	74LVC_LVCH16373A v.5		
74LVC_LVCH16373A v.5	20021002	Product specification	-	74LVC_H16373A v.4		
74LVC_H16373A v.4	19980317	Product specification	-	74LVC16373A_74LVCH16373A v.3		
74LVC16373A_74LVCH16373A v.3	19980317	Product specification	-	74LVC16373A v.2		
74LVC16373A v.2	19970822	Product specification	-	74LVC16373A v.1		
74LVC16373A v.1	-	-	-	-		

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15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	3] Definition		
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.		
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.		
Product [short] data sheet	Production	This document contains the product specification.		

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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